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1114C-0005 Series Single Color 1608 (h=0.4 mm) Type

Features

Package	1608 (h=0.4mm) Type, Milky White resin					
Product features	•Outer Dimension 1.6 x 0.8 x 0.4mm (LxWxH) •Temperature range Storage Temperature :-40°C~100°C Operating Temperature :-40°C~ 85°C •Lead-free soldering compatible •RoHS compliant					
Dominant wavelength	Yellow Green : 572nm(YPY) Yellow : 590nm(FY) Orange : 605nm(FA) Red : 626nm(FR)					
Spatial distribution	$\theta x = 130 \text{ deg.}, \ \theta y = 150 \text{ deg.}$					
Die materials	AlGaInP					
Rank grouping parameter	Sorted by luminous intensity and wavelength per rank taping					
Assembly method	Auto pick & place machine (Auto Mounter) Reflow soldering and manual soldering					
Soldering methods	Reflow soldering and manual soldering					
Taping and reel	4,000pcs per reel in a 8mm width tape. (Standard) Reel diameter: ϕ 180mm					
ESD	1kV (HBM)					

Recommended Applications







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Color and Luminous Intensity

(Ta=25℃)

Part No.	Material	Emitted Color	Lens Color	Wave	inant length (nm)	Lum	inous Inte	nsity
				TYP.	I _F	MIN.	TYP.	I _F
YPY1114C-0005	AlGaInP	Yellow Green		572	5	4.0	10	5
FY1114C-0005	AlGaInP	Yellow	range White	590	5	6.3	16	5
FA1114C-0005	AlGaInP	Orange		605	5	6.3	16	5
FR1114C-0005	AlGaInP	Red		626	5	6.3	16	5

Note: The above luminous intensity(I $_{v}$) is the setup values of the sorting machine. (Tolerance: I $_{v}$... $\pm\,10\%$)





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Absolute Maximum Ratings

(Ta=25℃)

Item	Completel	Abs	11			
	Symbol	YPY	FY	FA	FR	Unit
Power Dissipation	P_d	36	36	36	36	mW
Forward Current	I _F	15	15	15	15	mA
Pulse Forward Current ^{**1}	I _{FRM}	48	48	48	48	mA
Derating	⊿I _F	0.21	0.21	0.21	0.21	mA/°C
(Ta=25°C or higher)	⊿I _{FRM}	0.69	0.69	0.69	0.69	mA/℃
Reverse Voltage	V_R	5	5	5	5	V
Operating Temperature	T _{opr}		င			
Storage Temperature	T _{stg}		-40~	+100		ဗ

※1 I_{FRM}Measurement condition : Pulse Width≤1ms., Duty≤1/20.





HEAT Single Color 1608 (h=0.4 mm) Type

Electro-Optical Characteristics

(Ta=25℃)

l4om		CII	Characteristics					11
Item	Conditions	Symbol		YPY	FY	FA	FR	Unit
Famurand Valtage	I F A	V	TYP.	1.9	1.9	1.9	1.9	v
Forward Voltage I _F =5mA	I _F =3IIIA	V _F	MAX.	2.4	2.4	2.4	2.4	V
Reverse Current	V _R =5V	I _R	MAX.	100	100	100	100	μΑ
Peak Wavelength	I _F =5mA	λ,	TYP.	575	592	609	635	nm
Dominant Wavelength	I _F =5mA	λ _d	TYP.	572	590	605	626	nm
Spectral Line Half Width	I _F =5mA	Δλ	TYP.	15	15	15	15	nm
Half Intensity Angle	I _E =5mA	0.04/0	TYP.	130(θ x)	130(θ x)	130(θ x)	130(θ x)	deg.
	IF-3IIIA	2 θ 1/2	117.	150(θ y)	150(θy)	150(θy)	150(θy)	ueg.





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Luminous Intensity Rank

(Ta=25℃)

Intensity Tolerance each Rank: +/- 10%

	I _V (mcd)								
Rank	YF	ΡΥ	F	Y	F	4	F	R	Condition
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Α	4.0	6.3	6.3	10.0	6.3	10.0	6.3	10.0	
В	6.3	10.0	10.0	16.0	10.0	16.0	10.0	16.0	
C	10.0	16.0	16.0	25.0	16.0	25.0	16.0	25.0	$I_F = 5mA$
D	16.0	25.0	25.0	40.0	25.0	40.0	25.0	40.0	
E	25.0	-	40.0	-	40.0	-	40.0	-	

Please contact our sales staff concerning rank designation.

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Single Color 1608 (h=0.4 mm) Type

Color Tone Groups (λ d)

(Ta=25℃)

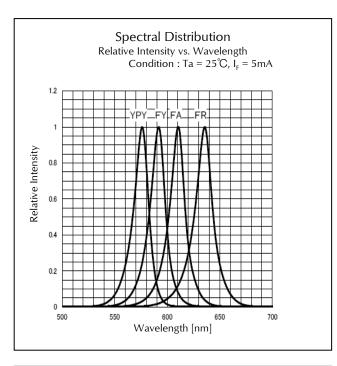
		Dominant Wavelength λ d (nm)							
Rank	YI	PY	F	Υ	F.	A	F	R	Condition
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Α	566.0	578.0	581.5	585.0	596.1	600.9	621.0	632.0	
В			584.0	587.5	599.1	603.9			
С			586.5	590.0	602.1	606.9			I - 5m A
D			589.0	592.5	605.1	609.9	/		$I_F = 5mA$
E			591.5	595.0	608.1	612.9			
F			594.0	597.5					

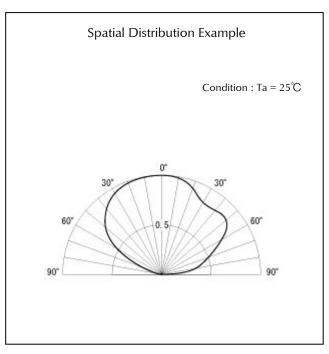
Please contact our sales staff concerning rank designation.

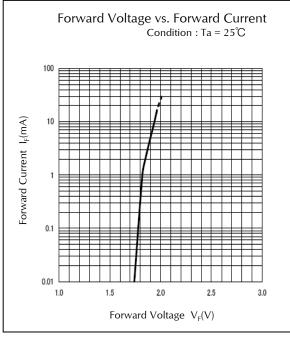


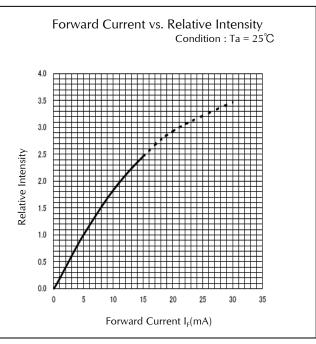


Technical Data(YPY/FY/FA/FR)





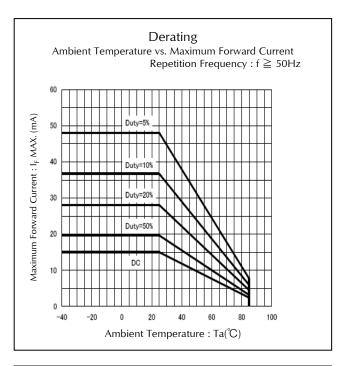


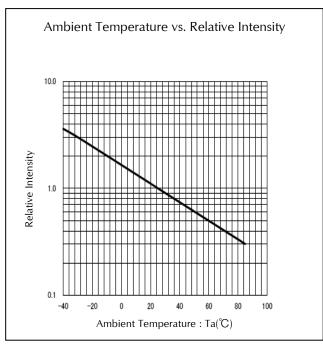


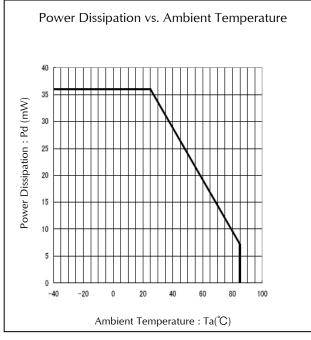


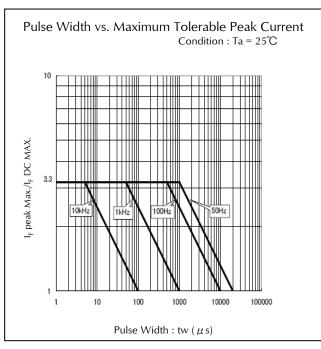


Technical Data(YPY/FY/FA/FR)





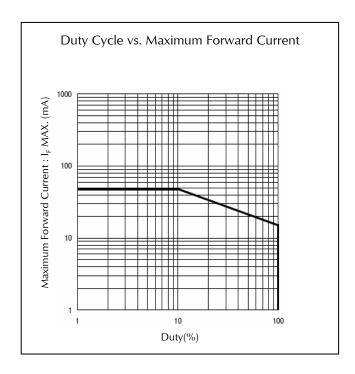


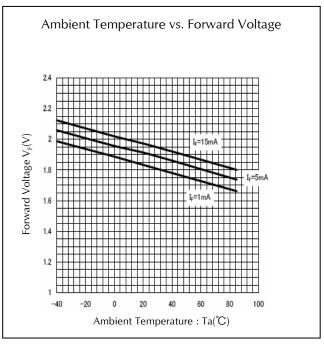






Technical Data(YPY/FY/FA/FR)







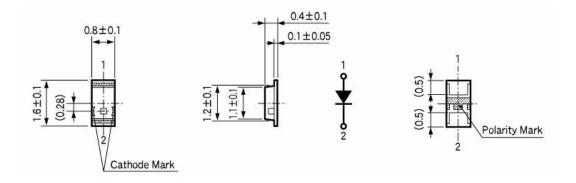


Single Color 1608 (h=0.4 mm) Type

Package Dimensions

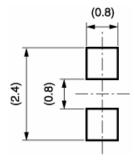
(Unit: mm)

Weight: (1.32)mg



Recommended Soldering Pattern

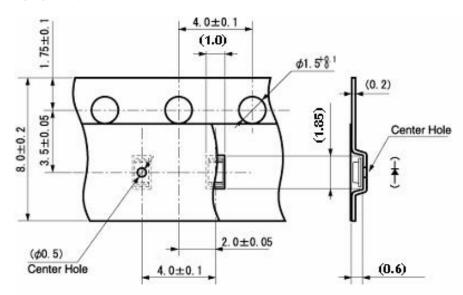
(Unit: mm)



Taping Specification

(Unit: mm)

Quantity: 4,000pcs/reel (standard)



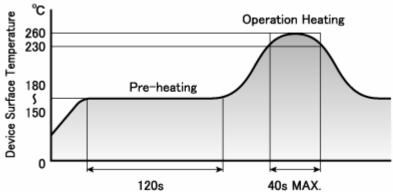
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1114C-0005 Series
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Reflow Soldering Conditions



- 1) The above profile temperature gives the maximum temperature of the LED resin surface. Please set the temperature so as to avoid exceeding this range.
- 2) Total times of reflow soldering process shall be no more than 2 times. When the second reflow soldering process is performed, intervals between the first and second reflow should be short as possible (while allowing some time for the component to return to normal temperature after the first reflow) in order to prevent the LED from absorbing moisture.
- 3) Temperature fluctuation to the LED during the pre-heating process shall be minimized. (6 maximum)

Manual Soldering Conditions

Iron tip temp.	350 ° Ç	(MAX.)
Soldering time and frequency	3 s 1 time	(MAX.) (MAX.)

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Handling

These types are designed chiefly for Cellular phone application, and are setting the thickness of the Product to about 0.4-0.5 mm thinly. To achieve the tin type of the product, making each material thin is aimed at. Because they are inferior to our general LEDs by an external stress, please use these product types after paying attention to the following.

1)Please set the mounting load to Max. 2N.

2)Please do not increase more quantity of the soldering paste than necessary quantity
(The thickness of stencil Mask: about 100-120µ), because the terminal area of the product is small.

3)Please avoid the collision of the mounting board etc. after LEDs were mounted on the substrate.
4)When warp of substrate is large after these were mounted on EPC etc. please use these product to

4)When warp of substrate is large after these were mounted on FPC etc, please use these product types after affirming these is no problem.

5)Please use these product types after affirming there is no problem about the mounting position etc. of product from substrate edge, when mounting them on multi-layer and multi-piece PCBs.





Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED- 4701/100(101)	Ta = 25°C, IF = Maxium Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED- 4701/300(301)	Pre-heating: 150∼180°C 120s Max. Operation Heating: 230°C 40s Max. Peak Temperature: 260°C	Twice	0/25
Temperature Cycling	EIAJ ED- 4701/100(105)	Minimum Rated Storage Temperature(30min) Normal Temperature(15min) Maximum Rated Storage Temperature(30min) Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED- 4701/100(103)	$Ta = 60\pm2$ °C, RH = 90 ± 5 %	1,000 h	0/25
High Temp. Storage Life	EIAJ ED- 4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED- 4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Vibration, Variable Frequency	EIAJ ED- 4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	lv	IF Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	VF	IF Value of each product Forward Voltage	Testing Max. Value ≧ Spec. Max. Value x 1.2
Reverse Current	I R	Vr = Maximum Rated Reverse Voltage V	Testing Max. Value ≧ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

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